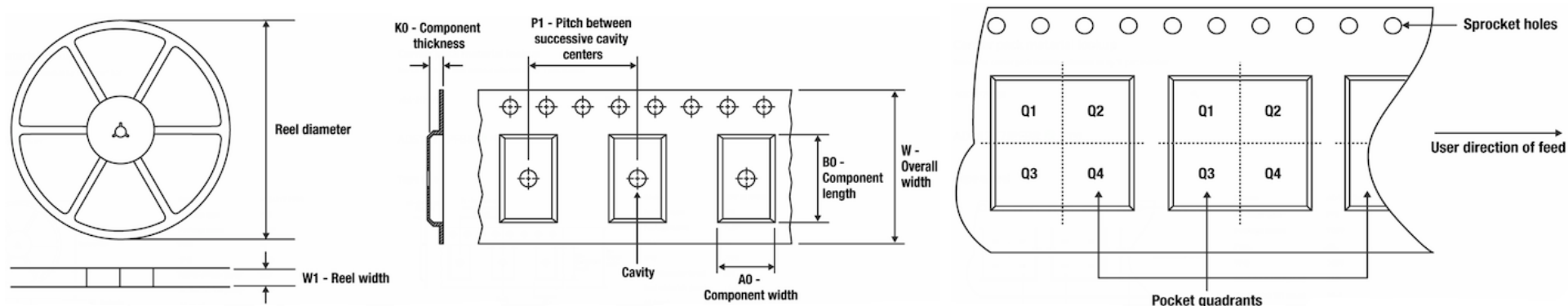


## Carrier Material Report for CD74HCT74M96

### Tape And Reel Information:



| Device        | Package Name | Package Type | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|--------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74HC T74M96 | D            | SOIC         | 14   | 2500 | 330                | 16.4               | 6.5     | 9       | 2.1     | 8       | 16     | Q1            |
| CD74HC T74M96 | D            | SOIC         | 14   | 2500 | 330                | 16.4               | 6.5     | 9       | 2.1     | 8       | 16     | Q1            |
| CD74HC T74M96 | D            | SOIC         | 14   | 2500 | 330                | 16.4               | 6.6     | 9.3     | 2.1     | 8       | 16     | Q1            |

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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